

Z-PACK | Z-PACK HM-Zd+

TE Internal #: 2065769-1 High Speed Backplane Connectors, Board-to-Board, 40 Position, Mating Alignment, Polarization Mating Alignment Type, 4 Row, 10 Column, Z-PACK HM-Zd+

View on TE.com >

Connectors > PCB Connectors > Backplane Connectors > High Speed Connectors



Connector System: Board-to-Board Number of Positions: 40 Row-to-Row Spacing: 1.5 mm [.059 in] Mating Alignment: With

Mating Alignment Type: Polarization

Features

Connectivity

Product Type Features

Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Receptacle
Shroud Style	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Pairs per Column	2
Number of Ground Positions	40
Number of Pairs	40
Number of Signal Positions	40
Number of Positions	40
Number of Rows	4
Number of Columns	10
PCB Mount Orientation	Right Angle

High Speed Backplane Connectors, Board-to-Board, 40 Position, Mating Alignment, Polarization Mating Alignment Type, 4 Row, 10 Column, Z-PACK HM-Zd+



Guide Location	Unguided
Electrical Characteristics	
Operating Voltage	250 VAC
Signal Characteristics	
Data Rate	≤12 Gb/s
Body Features	
Shield Material	Phosphor Bronze
Contact Features	
Contact Layout	Matrix
Contact Type	Receptacle
Contact Type	Receptacle
Contact Type Contact Mating Area Plating Material Thickness	Receptacle .76 µm[30 µin]
Contact Type Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material	Receptacle .76 µm[30 µin] Tin-Lead
Contact Type Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Contact Base Material	 Receptacle .76 µm[30 µin] Tin-Lead Copper Nickel Silicon
Contact Type Contact Mating Area Plating Material Thickness Contact Mating Area Plating Material Contact Base Material Contact Current Rating (Max)	 Receptacle .76 µm[30 µin] Tin-Lead Copper Nickel Silicon

Mechanical Attachment

Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Polyester - GF
Housing Color	Gray
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	24.9 mm[.98 in]
Connector Height	11.35 mm[.446 in]
Connector Width	18.9 mm[.744 in]
Row-to-Row Spacing	1.5 mm[.059 in]
Usage Conditions	

High Speed Backplane Connectors, Board-to-Board, 40 Position, Mating Alignment, Polarization Mating Alignment Type, 4 Row, 10 Column, Z-PACK HM-Zd+



Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tube
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224)
	Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC

homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

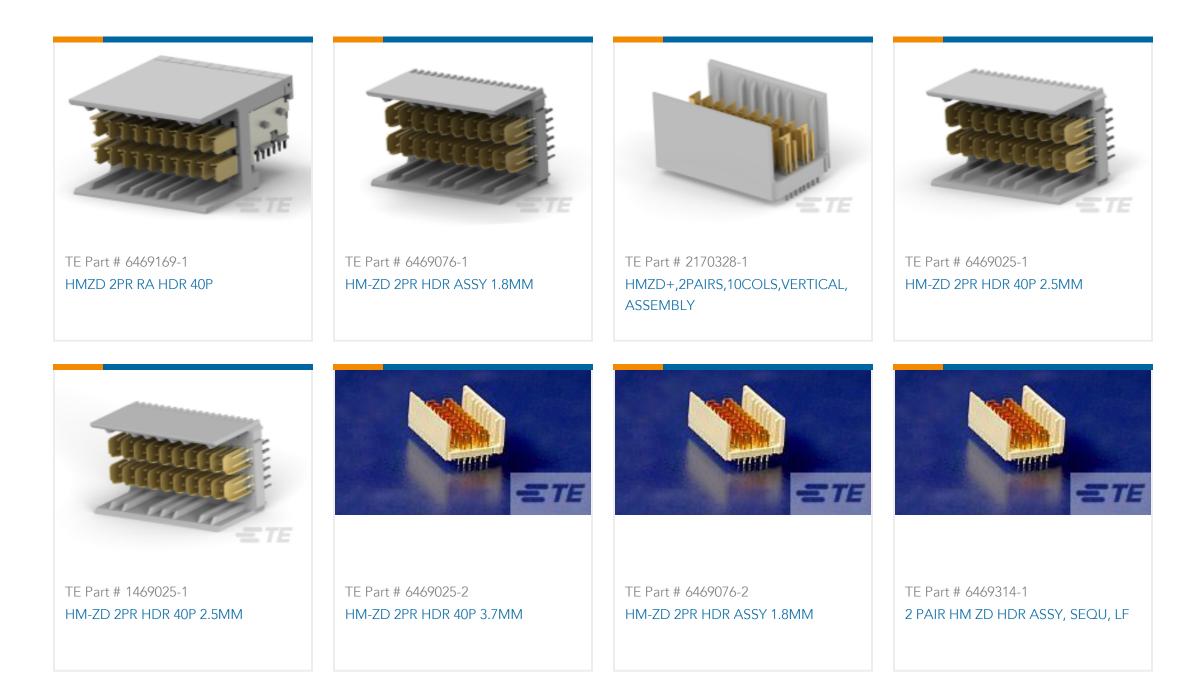
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

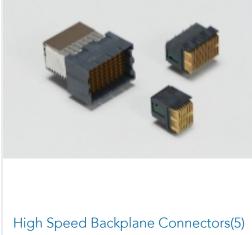
Compatible Parts

High Speed Backplane Connectors, Board-to-Board, 40 Position, Mating Alignment, Polarization Mating Alignment Type, 4 Row, 10 Column, Z-PACK HM-Zd+





Also in the Series Z-PACK HM-Zd+





Documents

Product Drawings Zd Plus 2 pair receptacle assy

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2065769-1_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2065769-1_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2065769-1_E.3d_stp.zip

English

High Speed Backplane Connectors, Board-to-Board, 40 Position, Mating Alignment, Polarization Mating Alignment Type, 4 Row, 10 Column, Z-PACK HM-Zd+



By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages 5-1773463-9_Z-PACK_HM-ZD_PLUS_CONNECTOR

English

Product Specifications Application Specification

English